# **MP7612**

Octal 12-Bit DAC Array<sup>TM</sup> D/A Converter with Output Amplifier and Serial Data/Address μP Control Logic

## **FEATURES**

Eight Independent 12-Bit DACs with Output Amplifiers

**XEXAR** ... the analog plus company<sup>TM</sup>

- Low Power 320 mW (typ.)
- Serial Digital Data and Address Port (3-Wire Standard)
- 12-Bit Resolution, 11 Bit Accuracy
- **Extremely Well Matched DACs**
- Extremely Low Analog Ground Current (<60µA/Channel)
- +10 V Output Swing with +11.4 V Supplies
- Zero Volt Output Preset (Data = 10 .. 00)
- **Rugged Construction Latch-Up Free**
- Parallel Version: MP7613

## **APPLICATIONS**

April 1996-4

- **Data Acquisition Systems**
- ATE
- **Process Control**
- Self-Diagnostic Systems
- Logic Analyzers
- **Digital Storage Scopes**
- PC Based Controller/DAS

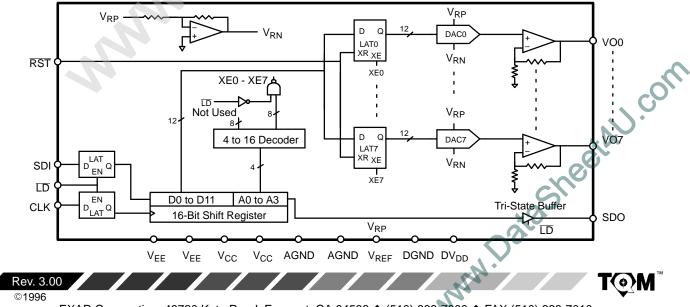
## **GENERAL DESCRIPTION**

The MP7612 provides eight independent 12-bit resolution Digital-to-Analog Converters with voltage output amplifiers and a 3-wire standard serial digital address and data port.

Typical DAC matching for B grade versions is 0.7 LSB across all codes. Accuracy of ±0.75 LSB for DNL and ±1 LSB for INL is also achieved for B grades. The output amplifier is capable of sinking and sourcing 5mA, and the output voltage settles to 12-bits in less than 30µs (typ.).

The MP7612 is equipped with a serial data (3-wire standard) µ-processor logic interface to reduce pin count, package size, and board space.

Built using an advanced linear BiCMOS, these devices offer rugged solutions that are latch-up free, and take advantage of EXAR's patented thin-film resistor process which exhibits excellent long term stability and reliability.



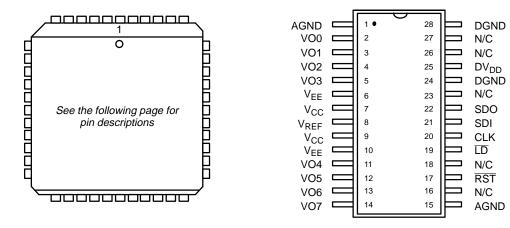
EXAR Corporation, 48720 Kato Road, Fremont, CA 94538 (510) 668-7000 FAX (510) 668-7010

#### SIMPLIFIED BLOCK DIAGRAM

## **ORDERING INFORMATION**

Package Type	Temperature Range	Part No.	Res. (Bits)	INL (LSB)	DNL (LSB)	FSE (LSB)
PLCC	–40 to +85°C	MP7612BP	12	±1	±0.75	±6
PLCC	–40 to +85°C	MP7612AP	12	±2	±1	±8
SOIC	–40 to +85°C	MP7612BS	12	±1	±0.75	±6
SOIC	–40 to +85°C	MP7612AS	12	±2	±1	±8

## **PIN CONFIGURATIONS**



44 Pin PLCC

28 Pin SOIC (Jedec, 0.346")





## **PIN DESCRIPTION**

SOIC Pin #	PLCC Pin #	Symbol	Description
1	2	AGND	Analog Ground
2	3	VO0	DAC 0 Output
3	4	VO1	DAC 1 Output
4	5	VO2	DAC 2 Output
5	6	VO3	DAC 3 Output
6	7	V <sub>EE</sub>	Analog Negative Power Supply (-12 V)
7	9	V <sub>CC</sub>	Analog Positive Power Supply (+12 V)
8	12	V <sub>REF</sub>	Voltage Reference Input (+5 V)
9	13	V <sub>CC</sub>	Analog Positive Power Supply (+12 V)
10	15	V <sub>EE</sub>	Analog Negative Power Supply (-12 V)
11	18	VO4	DAC 4 Output
12	19	VO5	DAC 5 Output
13	20	VO6	DAC 6 Output
14	21	VO7	DAC 7 Output
15	24	AGND	Analog Ground
16		N/C	No Connection
17	26	RST	Reset all DACs to 0 V Output
18		N/C	No Connection
19	29	LD	Load Signal; Load Data to Selected DAC
20	31	CLK	Serial Data Clock
21	32	SDI	Serial Data Input
22	34	SDO	Shift Register Serial Output
23		N/C	No Connection
24	37	DGND	Digital Ground
25	40	DV <sub>DD</sub>	Digital Positive Power Supply (+5 V)
26		N/C	No Connection
27	1, 8, 10, 11, 14, 16, 17, 22, 23, 25, 27, 28, 30, 33, 35, 36, 38, 39, 41, 42, 43	N/C	No Connection
28	44	DGND	Digital Ground





## ELECTRICAL CHARACTERISTICS

 $V_{CC}$  = +12 V,  $V_{EE}$  = -12 V,  $V_{REF}$  = 5 V,  $DV_{DD}$  = 5.0 V, T = 25°C, Output Load = 5k $\Omega$  (unless otherwise noted)

Parameter	Symbol	Min	25 <sup>°</sup> С Тур	Max	Tmin to Min	Tmax Max	Units	Test Conditions/Comments
STATIC PERFORMANCE								
Resolution (All Grades)	N	12					Bits	
Integral Non-Linearity (Relative Accuracy) A B	INL			土2 土1		土2 土1	LSB	End Point Linearity Spec
Differential Non-Linearity A B	DNL			土1 土0.75		土1 土0.75	LSB	
Positive Full Scale Error A B	+FSE		6 4	土8 土6		土8 土6	LSB	
Negative Full Scale Error A B	-FSE		6 4	土8 土6		土8 土6	LSB	
Bipolar Zero Offset A B	ZOFS			$^{\pm4}_{\pm3}$		土4 土3	LSB	
INL Matching A B	ΔINL			土2 土1.5		土2 土1.5	LSB	
All Channels Maximum Error with DAC 0 adjusted to minimum error A B	ME			±4 ±2		±4 ±2	LSB	
Bipolar Zero Matching A B	∆ZOFS			$\pm 4$ $\pm 3$		$\pm 4$ $\pm 3$	LSB	
Full Scale Error Matching A B	FSE			$^{\pm4}_{\pm3}$		土4 土3	LSB	
DYNAMIC PERFORMANCE								
Voltage Settling from LD to VDAC Out <sup>1</sup> Channel-to-Channel Crosstalk <sup>1, 6</sup> Digital Feedthrough <sup>1, 6</sup> Power Supply Rejection Ratio	t <sub>sd</sub> CT Q PSRR		30 0.04 –70	50 5		50	μsec LSB dB ppm/%	ZS to FS (20 V Step) DC CLK and Data to V <sub>OUTi</sub> $\Delta V_{EE} \& \Delta V_{CC} = \pm 5\%$ , ppm of FS
REFERENCE INPUTS								
Impedance of V <sub>REF</sub> V <sub>REF</sub> Voltage1, <sup>2</sup>	REF V <sub>REF</sub>	350 3.5	700	1.05k 6	350	1.05k	Ω V	See Application Hints for driving the reference input





## **ELECTRICAL CHARACTERISTICS (CONT'D)**

Parameter	Symbol	Min	25 <sup>°</sup> С Тур	Max	Tmin to Min	Tmax Max	Units	Test Conditions/Comments
DIGITAL INPUTS <sup>3</sup>			.76	max				
Logic High Logic Low Input Current Input Capacitance <sup>1</sup>	V <sub>IH</sub> V <sub>IL</sub> IL CL	2.4		0.8 <u>+</u> 10 8			V V μA pF	
ANALOG OUTPUTS								
Output Swing Output Drive Current Output Impedance Output Short Circuit Current	R <sub>O</sub> Isc	-V <sub>EE</sub> +1.4 -5	V <sub>CC</sub> 1 25 30 40 55	-1.4 5			V mA mA mA mA mA	+FS to AGND +FS to V <sub>EE</sub> –FS to AGND –FS to V <sub>CC</sub>
DIGITAL OUTPUTS								
Output High Voltage Output Low Voltage	V <sub>OH</sub> V <sub>OL</sub>		4.5 0.5				V V	
POWER SUPPLIES								
V <sub>CC</sub> Voltage <sup>5</sup> V <sub>EE</sub> Voltage <sup>5</sup> DV <sub>DD</sub> Voltage Positive Supply Current Negative Supply Current Digital Supply Current Power Dissipation	V <sub>CC</sub> V <sub>EE</sub> DV <sub>DD</sub> I <sub>CC</sub> I <sub>DD</sub> PD <sub>ISS</sub>	V <sub>REF</sub> +1.5 –12.75 4.5	12 -12 5 8 15 320	12.75 -5 5.5 10 20 2 420	V <sub>REF</sub> +1.5 -12.75 4.5	12.75 -5 5.5 10 20 2 450	V V mA mA mW	Bipolar zero Bipolar zero Bipolar zero Bipolar zero
ANALOG GROUND CURRENT								
Per Channel <sup>1</sup>	I <sub>AGND</sub>		±60				μΑ	See Application Notes
DIGITAL TIMING SPECIFICATIONS <sup>1,4</sup> Input Clock Pulse Width Data Setup Time Data Hold Time CLK to SDO Propagation Delay DAC Register Load Pulse Width Preset Pulse Width Clock Edge to Load Time ID Falling Edge to SDO Tri-state Enable ID Rising Edge to SDO Tri-state Disable ID Rising Edge to CLK Enable ID Set-up Time with Respect to CLK	t <sub>CH</sub> , t <sub>CL</sub> t <sub>DS</sub> t <sub>DH</sub> t <sub>PD</sub> t <sub>LD</sub> t <sub>PR</sub> t <sub>CKLD1</sub> t <sub>CKLD2</sub> t <sub>HZ1</sub> t <sub>HZ2</sub>	35 15 15 35 50 140 0 50 50 50 30		40			ns ns ns ns ns ns ns ns ns	$V_{IL} = 0$ , $V_{IH} = 5.0$ , $C_L = 20 \text{ pF}$ Note: $t_{LD}$ and $t_{CKLD2}$ cannot both be min. since $t_{CKLD1} = t_{CKLD2} + t_{LD}$





## **ELECTRICAL CHARACTERISTICS (CONT'D)**

#### NOTES:

- <sup>1</sup> Guaranteed; not tested.
- <sup>2</sup> Specified values guarantee functionality.
- <sup>3</sup> Digital inputs should not go below digital GND or exceed DV<sub>DD</sub> supply voltage.
- <sup>4</sup> See Figures 2 and 3. All digital input signals are specified with  $t_R = t_F = 10$  ns 10% to 90% and timed from a 50% voltage level.
- <sup>5</sup> For power supply values <  $\pm 2 * V_{REF}$ , the output swing is limited as specified in Analog Outputs.
- <sup>6</sup> Digital feedthrough and channel-to-channel crosstalk are heavily dependent on the board layout and environment.

#### Specifications are subject to change without notice

/ / / / / /

#### ABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)<sup>1, 2</sup>

V <sub>CC</sub> to AGND	Analog Inputs & Outputs Indefinite Shorts to V <sub>CC</sub> , V <sub>EE</sub> , DV <sub>DD</sub> , AGND, DGND (provided that power dissipation of the package spec is not exceeded)
DV <sub>DD</sub> to DGND	Operating Temperature Range Extended Industrial
V <sub>REF</sub> to DGND +7.0 V	Maximum Junction Temperature –65°C to 150°C
VREF 10 DGND +7.0 V	Storage Temperature150°C
AGND to DGND $\pm 1 \text{ V}$ (Functionality guaranteed for $\pm 0.5 \text{ V}$ only)	Lead Temperature (Soldering, 10 sec) +300°C
Digital Input & Output Voltage to DGND -0.5 to DV <sub>DD</sub> +0.5V	Package Power Dissipation Rating @ 75°C SOIC, PLCC 1150mW Derates above 75°C 15mW/°C

#### NOTES:

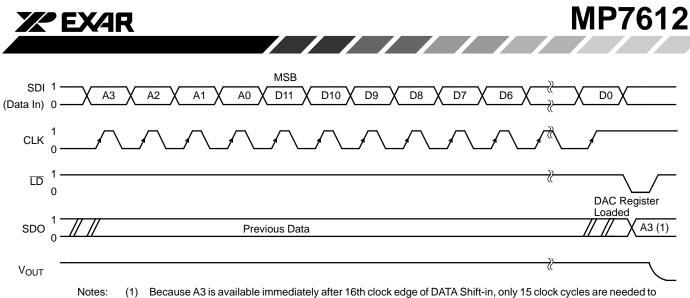
Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies. *All inputs have protection diodes* which will protect the device from short transients outside the supplies of less than 100mA for less than 100µs.

### APPLICATION NOTES Refer to Section 8 in the 1995 Data Acquisition products Databook for Applications Information

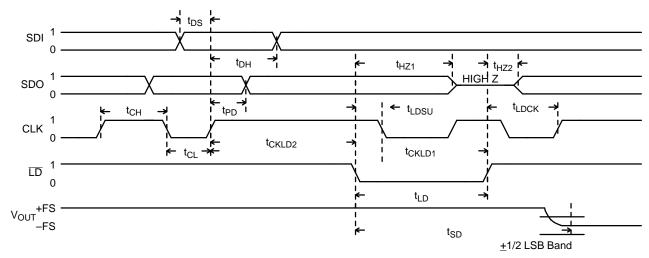
NOTE: When using these DACs to drive remote devices, the accuracy of the output can be improved by utilizing a remote analog ground connection. The difference between the DGND and AGND should be limited to  $\pm$ 300 mV to assure normal operation. If there is any chance that the AGND to DGND can be greater than  $\pm$ 1 V, we recommend two back-to-back diodes be used between DGND and AGND to clamp the voltage and prevent damage to the DAC. Using a buffer between the remote ground location and AGND may help reduce noise induced from long lead or trace lengths.

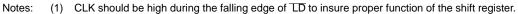




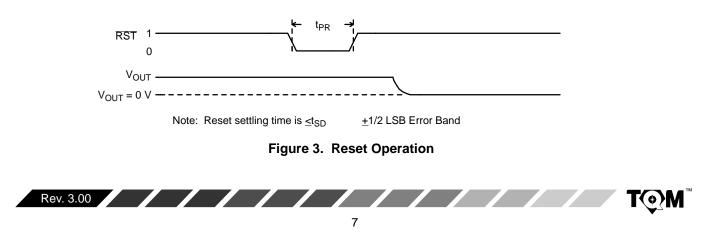
(1) Because A3 is available immediately after 16th clock edge of DATA Shift-in, only 15 clock cycles are needed to complete the readback.

Figure 1. Serial Data Timing and Loading









**MP7612** 



The MP7612 is equipped with a serial data (3-wire standard)  $\mu$ -processor logic interface to reduce pin count, package size, and board wire (space). If the  $\overline{\text{LD}}$  signal is high, the CLK signal loads the digital input bits (SDI) into the shift register (4 bits address A3 to A0 plus 12 bits data DB11 to DB0 for the MP7612). The  $\overline{\text{LD}}$  signal going low loads the data into the selected DAC.

The  $\overline{\text{LD}}$  signal going low also disables the serial data (SDI), output (SDO 3-stated) and the CLK input. This design tremendously reduces digital noise and glitch transients into the DACs due to free running CLK and SDI. Note also that the preset signal ( $\overline{\text{RST}}$ ) resets all analog outputs to 0 volt regardless of digital inputs.

Function	A3	A2	A1	A0	LD	CLK	RST	SDI	SDO
Shift Data In and Out	Х	Х	Х	Х	1	0→1 Repeat	1	Data Input Valid	Data Output Valid
Stop Shifting Data In and Out	Х	Х	Х	Х	0	Х	1	Х	Hi-Z
Load DACs DAC 0 DAC 1 DAC 2 DAC 3 DAC 4 DAC 5 DAC 6 DAC 7	0 0 0 0 0 0 0 1 1	0 0 0 1 1 1 0 	0 0 1 1 0 0 1 1 0 	0 10101010 10101010101	No Operation $1 \rightarrow 0$ $1 \rightarrow 0$ $1 \rightarrow 0$ $1 \rightarrow 0$ $1 \rightarrow 0$ $1 \rightarrow 0$ $1 \rightarrow 0$ No Operation	****	1 1 1 1 1 1 1 1 1	××××××× ××	Hi-Z Hi-Z Hi-Z Hi-Z Hi-Z Hi-Z Hi-Z Hi-Z
Reset all DACs to 0 V	X	X	X	X	No Operation X	x	0	X	X

## Table 1. Digital Function Truth TableSerial In/Serial Out

Note: For timing information see Electrical Characteristics





Hex Code	Binary Code	Output Voltage = 2 • Vr (-1 + <u>2•D</u> ) (Vr = +5 V) 4096
000	000000000000	10 • (-1 + 0) = -10
7 F F	01111111111	$10 \bullet (-1 + \frac{4094}{4096}) = -4.88 \text{ mV}$
800	100000000000	$10 \bullet (-1 + \frac{4096}{4096}) = 0$
801	10000000001	$10 \bullet (-1 + \frac{4098}{4096}) = 4.88 \text{ mV}$
FFF	11111111111	$10 \bullet (-1 + \frac{8190}{4096}) = 9.99512$

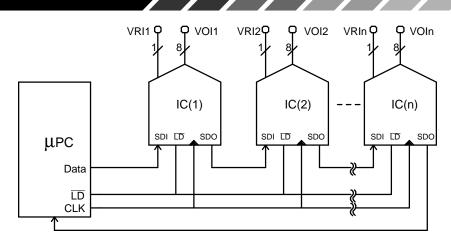
**MP7612** 

Table 2.MP7612Ideal DAC Output vs. Input Code

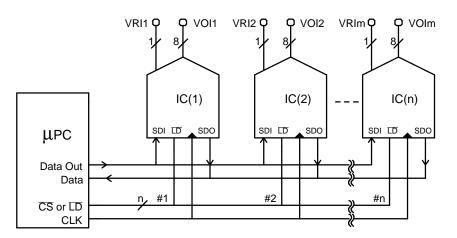
Note: See Electrical Characteristics for real system accuracy













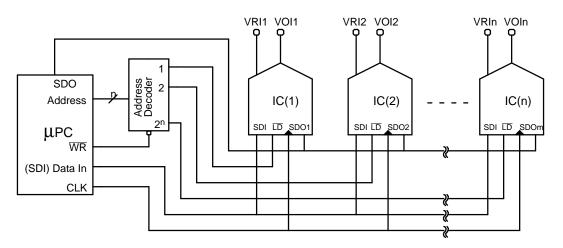
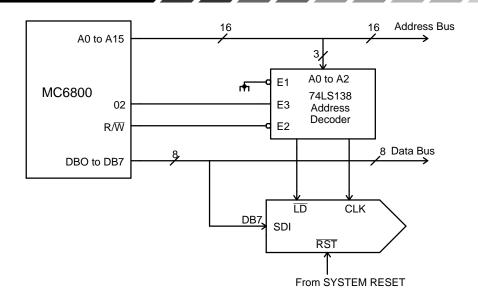


Figure 6. Simplified Diagram



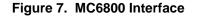


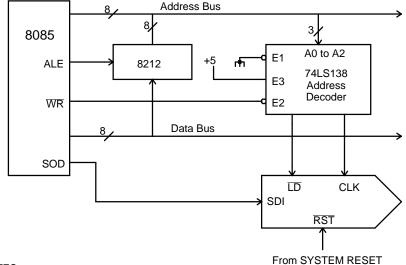
## MP7612



#### NOTES

- 1. Execute consecutive memory write instructions while manipulating the data between WRITEs so that each WRITE presents the next bit.
- 2. The serial data loading is triggered by the CLK pulse which is asserted by a decoded memory WRITE to memory location 2000, R/W, and 02. A WRITE to address 4000 transfers data from input shift register to DAC register.





#### NOTES:

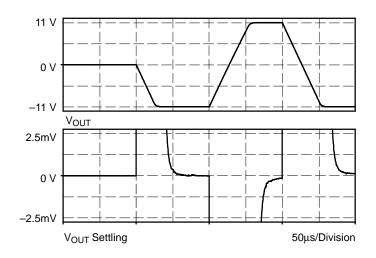
- 1. Clock generated by WR and decoding address 8000.
- 2. Data is clocked in the DAC shift register by executing memory write instructions. The clock input is generated by decoding address 8000 and WR. Data is then loaded into the DAC register with a memory write instruction to address 4000.
- 3. Serial data must be present in the right justified format in registers H & L of the microprocessor.

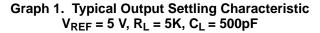
Figure 8. 8085 Interface



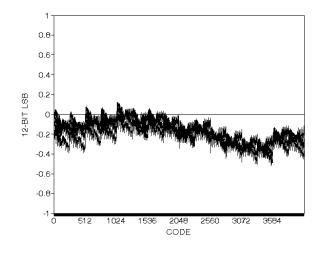


PERFORMANCE CHARACTERISTICS



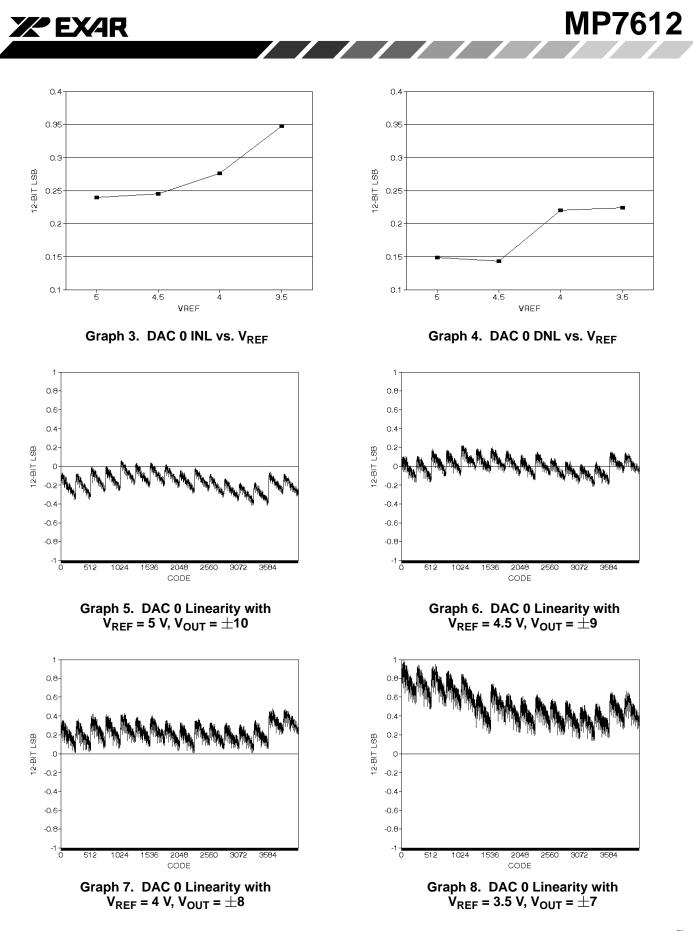


Graph 1 shows the typical output settling characteristic of the MP7610 Family for a RESET -> ZS -> FS -> ZS series of code transitions. The top graph shows the output voltage transients, while the bottom graph shows the difference between the output and the ideal output.

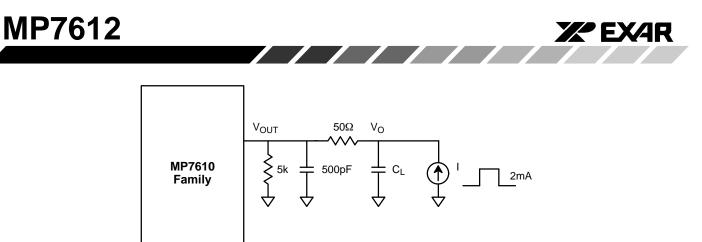


Graph 2. Linearity with  $V_{REF} = 5$  V, All DACs, All Codes



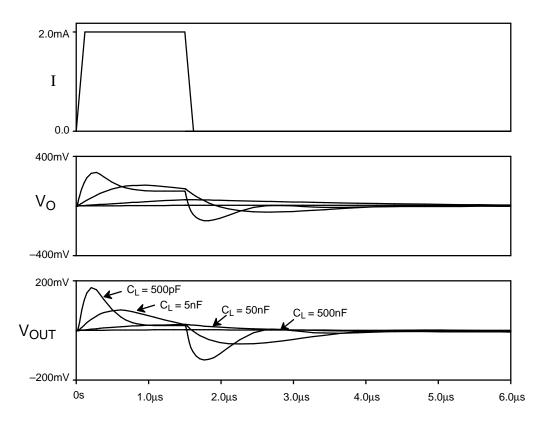


Rev. 3.00



CL = 500pF, 5nF, 50nF, 500nF



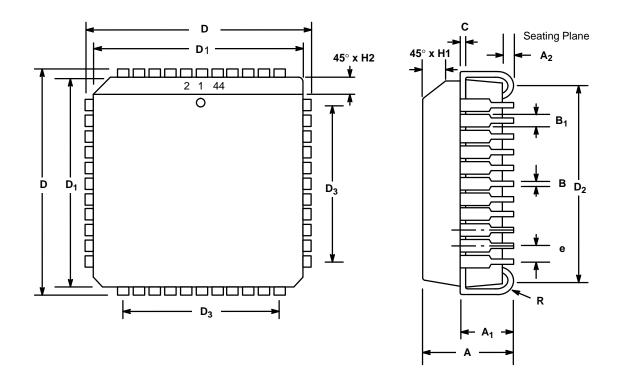


Graph 9. Typical Response of the MP7610 Family Analog Output to a Current Pulse with CL=500pF, 5nF, 50nF, 500nF (See Figure 9. above)





44 LEAD PLASTIC LEADED CHIP CARRIER (PLCC)



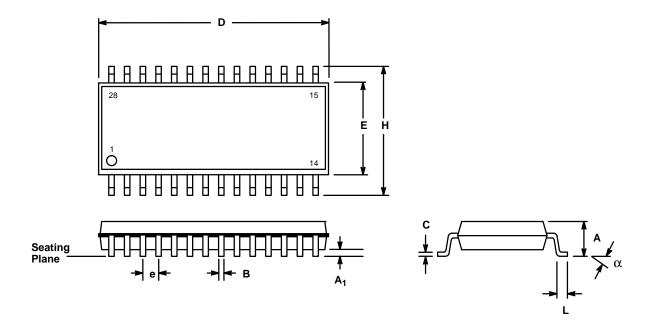
	INC	CHES	MILLI	METERS
SYMBOL	MIN	MAX	MIN	MAX
А	0.165	0.180	4.19	4.57
A <sub>1</sub>	0.090	0.120	2.29	3.05
A <sub>2</sub>	0.020		0.51	
В	0.013	0.021	0.33	0.53
B <sub>1</sub>	0.026	0.032	0.66	0.81
С	0.008	0.013	0.19	0.32
D	0.685	0.695	17.40	17.65
D <sub>1</sub>	0.650	0.656	16.51	16.66
D <sub>2</sub>	0.590	0.630	14.99	16.00
D <sub>3</sub>	0.5	00 typ.	12.7	70 typ.
е	0.0	50 BSC	1.2	7 BSC
H1	0.042	0.056	1.07	1.42
H2	0.042	0.048	1.07	1.22
R	0.025	0.045	0.64	1.14

Note: The control dimension is the inch column









	INC	HES	MILLIN	METERS
SYMBOL	MIN	MAX	MIN	МАХ
А	0.093	0.104	2.35	2.65
A <sub>1</sub>	0.004	0.012	0.10	0.30
В	0.013	0.020	0.33	0.51
С	0.009	0.013	0.23	0.32
D	0.706	0.718	17.93	18.24
E	0.340	0.350	8.64	8.89
е	0.0	50 BSC	1.2	7 BSC
Н	0.460	0.485	11.68	12.32
L	0.016	0.050	0.40	1.27
α	0°	8°	0°	8°

Note: The control dimension is the millimeter column





Notes





Notes





Notes





## NOTICE

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